

# **SPECIFICATION**

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SPEC. NO.:	PS-500	013-XXXXX-XXX	<b>REVISION:</b>	C
PRODUCT N	AME:	0.50mm PITCH BTI	B SMT S/T D/R CONNEC	CTOR
PRODUCT N	<b>O</b> :	50013-XXXXX-XXX	( 50014-XXXXX-XXX	

 PREPARED:
 CHECKED:
 APPROVED:

 TANGENHUI
 DAVID
 SIMON

 DATE:
 2014/01/18
 DATE:
 2014/01/18



#### TITLE: 0.50mm PITCH BTB SMT S/T D/R CONNECTOR

1	REVISION HISTORY	3
2	SCOPE	4
3	APPLICABLE DOCUMENTS	4
4	REQUIREMENTS	4
5	PERFORMANCE	5
6	INFRARED REFLOW CONDITION	7
7	CONNECTOR USAGE	8
8	PRODUCT QUALIFICATION AND TEST SEQUENCE	9



TITLE: 0.50mm PITCH BTB SMT S/T D/R CONNECTOR

## 1 Revision History

Rev.	ECN#	Revision Description	Prepared	Date
0	ECN-0812036	NEW SPEC	JASON	2008/12/06
Α	ECN-1106447	MODIFY MATING FORCE FOR 22~40PINS	XHX	2011/06/29
В	ECN-1112380	MODIFY PITCH 0.4mm TO 0.5mm	XHX	2011/12/21
С	ECN-1401255	ADD WORKING VOLTAGE	TANGENHUI	2014/01/18
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TITLE: 0.50mm PITCH BTB SMT S/T D/R CONNECTOR

#### 2 SCOPE

This specification covers performance, tests and quality requirements for 0.50mm pitch BTB connector. ACES P/N: 50013 Series; 50014 Series.

#### 3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

#### 4 REQUIREMENTS

- 4.1 Design and Construction
  - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
  - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
  - 4.2.1 Contact: High performance copper alloy

Finish: (a) Contact Area: Gold plated based on order information

(b) Under plate: Nickel-plated all over

4.2.2 Housing: Thermoplastic High Temp., UL94V-0

- 4.3 Ratings
  - 4.3.1 Working Voltage Less than 36 Volts AC (per pin)
  - 4.3.2 Voltage: 50 Volts AC (per pin)
  - 4.3.3 Current: 0.5 Amperes (per pin)
  - 4.3.4 Operating Temperature : -40°C to +80°C



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#### 5 Performance

## 5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard						
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.						
ELECTRICAL								
Item Requirement		Standard						
Low Level Contact Resistance	55 m Ω Max.(initial)per contact ΔR 10 m Ω Max.	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)						
Insulation Resistance	500 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)						
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	300 VAC Min. at sea level for 1 minute Test between adjacent contacts of unmated connectors. (EIA-364-20)						
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1)						
	MECHANICAL							
Item	Requirement	Standard						
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09)						
	Unit: Kg	Operation Speed :						
	Pins   Mating   Unmating   Force(Max)   Force(Min)   Initial   Final   Initial   Final	25.4 ± 3 mm/minute.  Measure the force required to mate/unmate connector.						
Mating / Unmating Forces	<20     2.0     1.0     0.2     0.2       22~40     2.0     1.5     0.4     0.3       42~80     5.0     4.0     0.5     0.4       82~120     5.0     4.0     0.8     0.6	(EIA-364-13)						
Terminal / Housing Retention Force	122~200 8.0 6.0 0.8 0.6 0.2kgf MIN.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute.						



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RELEASE DATE: 2014/01/18 REVISION: C ECN No: ECN-1401255 PAGE: **6** OF **9** 

	•	•				
		On the terminal assembled in the housing.				
Fitting Nail /Housing Retention Force	0.2kgf MIN.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the fitting nail assembled in the housing.				
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)				
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)				
	ENVIRONMENTAL					
14						
Item Resistance to Reflow Soldering Heat	Requirement  See Product Qualification and Test Sequence Group 9 (Lead Free)	Standard  Pre Heat: 150°C~180°C, 60~120sec.  Heat: 230°C Min., 40sec Min.  Peak Temp.: 260°C Max,  10sec Max.				
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles.				
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)				
Temperature life	See Product Qualification and Test Sequence Group 5					



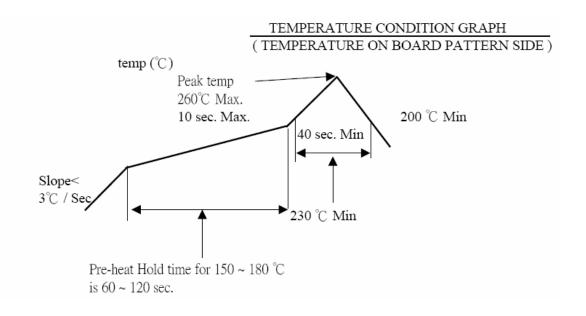
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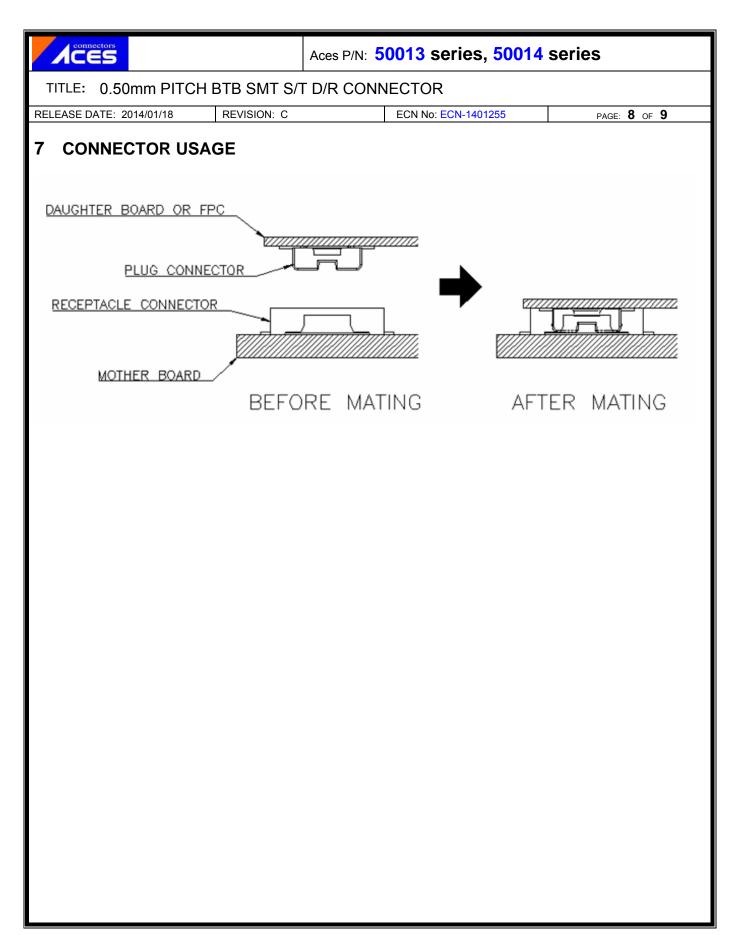
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		hours.			
		(EIA-364-17, Test condition A)			
		Subject mated/unmated			
ISAII Shrav	See Product Qualification and Test	connectors to 5% salt-solution			
	Sequence Group 6	concentration, 35°C for 8 hours.			
		(EIA-364-26,Test condition B)			
		And then into solder bath,			
Solder ability	Solder able area shall have	Temperature at 245 ±5°C, for 4-5			
	minimum of 95% solder coverage.	sec.			
		(EIA-364-52)			

Note. Flowing Mixed Gas shell be conduct by customer request.

#### 6 INFRARED REFLOW CONDITION

#### 6.1. Lead-free Process







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#### 8 PRODUCT QUALIFICATION AND TEST SEQUENCE

		Test Group									
Test or Examination	1	2	3	4	5	6	7	8	9		
		Test Sequence									
Examination of Product				1 . 7	1、6	1 \ 4			1		
Low Level Contact Resistance		1 \ 5	1 \ 4	2、10	2 ` 9	2 ` 5			3		
Insulation Resistance				3 . 9	3 · 8						
Dielectric Withstanding Voltage				4 \ 8	4 · 7						
Mating / Unmating Forces		2 \ 4									
Temperature rise	1										
Durability		3									
Vibration			2								
Shock (Mechanical)			3								
Thermal Shock				5							
Humidity				6							
Temperature life					5						
Salt Spray						3					
Solder ability							1				
Terminal / Housing Retention Force								1			
Fitting Nail /Housing Retention Force								2			
Resistance to Soldering Heat									2		
Sample Size	2	4	4	4	4	4	2	4	4		